

N-Channel Enhancement Mode Power MOSFET

■ Features

- Simple Drive Requirement
- Low On-resistance
- Fast Switching

■ Product Summary

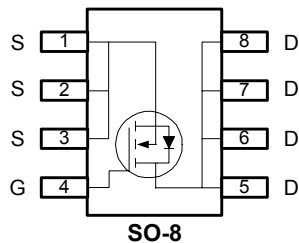
BV _{DSS} (V)	R _{DS(ON)} (mΩ)	I _D (A)
30	6	18

■ General Description

The advanced power MOSFET provides the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The SO-8 package is universally preferred for all commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters.

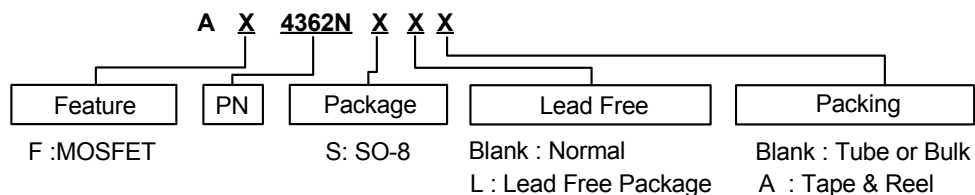
■ Pin Assignments



■ Pin Descriptions

Pin Name	Description
S	Source
G	Gate
D	Drain

■ Ordering information





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■ Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	± 12	V
I_D	Continuous Drain Current (Note 1)	$T_A=25^\circ\text{C}$	18
		$T_A=70^\circ\text{C}$	15
I_{DM}	Pulsed Drain Current (Note 2)	80	A
P_D	Total Power Dissipation	$T_A=25^\circ\text{C}$	2.5
	Linear Derating Factor		0.02
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

■ Thermal Data

Symbol	Parameter	Maximum	Units
$R_{thj-amb}$	Thermal Resistance Junction-ambient (Note 1)	Max. 50	$^\circ\text{C}/\text{W}$

■ Electrical Characteristics at $T_J=25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	30	-	-	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	Reference to 25°C , $I_D=1\text{mA}$	-	0.01	-	$\text{V}/^\circ\text{C}$
$R_{DS(ON)}$	Static Drain-Source On-Resistance (Note 3)	$V_{GS}=10\text{V}, I_D=18\text{A}$	-	-	5	m Ω
		$V_{GS}=4.5\text{V}, I_D=12\text{A}$	-	-	6	
		$V_{GS}=2.5\text{V}, I_D=6\text{A}$	-	-	8	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	-	-	1.2	V
g_{fs}	Forward Transconductance	$V_{DS}=10\text{V}, I_D=12\text{A}$	-	47	-	S
I_{DSS}	Drain-Source Leakage Current ($T_J=25^\circ\text{C}$)	$V_{DS}=30\text{V}, V_{GS}=0\text{V}$	-	-	1	μA
	Drain-Source Leakage Current ($T_J=70^\circ\text{C}$)	$V_{DS}=24\text{V}, V_{GS}=0\text{V}$	-	-	25	
I_{GSS}	Gate-Source Leakage	$V_{GS}=\pm 12\text{V}$	-	-	± 100	nA
Q_g	Total Gate Charge (Note 3)	$I_D=18\text{A}$	-	59	95	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=24\text{V}$	-	10	-	
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{GS}=4.5\text{V}$	-	23	-	
$t_{d(on)}$	Turn-On Delay Time (Note 3)	$V_{DS}=15\text{V}, I_D=1\text{A}, R_G=3.3\Omega, V_{GS}=10\text{V}, R_D=15\Omega$	-	16	-	ns
t_r	Rise Time		-	12	-	
$t_{d(off)}$	Turn-Off Delay Time		-	96	-	
t_f	Fall-Time		-	30	-	
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}$	-	5080	8100	pF
C_{oss}	Output Capacitance	$V_{DS}=25\text{V}$	-	660	-	
C_{rss}	Reverse Transfer Capacitance	$f=1.0\text{MHz}$	-	400	-	

■ Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_{SD}	Forward On Voltage (Note 3)	$I_S=18\text{A}, V_{GS}=0\text{V}$	-	-	1.2	V
t_{rr}	Reverse Recovery Time	$I_S=18\text{A}, V_{GS}=0\text{V}$	-	43	-	ns
Q_{rr}	Reverse Recovery Charge	$di/dt=100\text{A}/\mu\text{s}$	-	39	-	nC

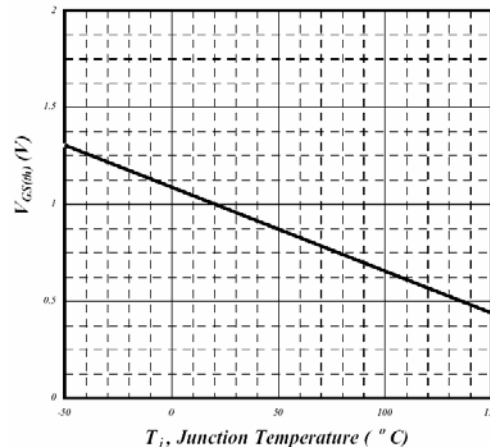
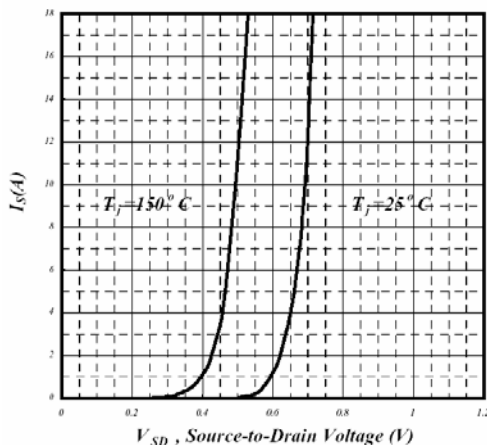
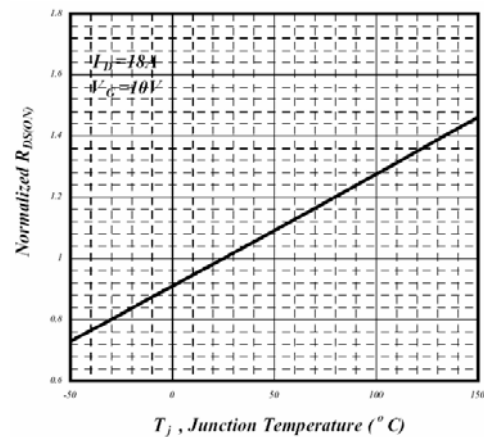
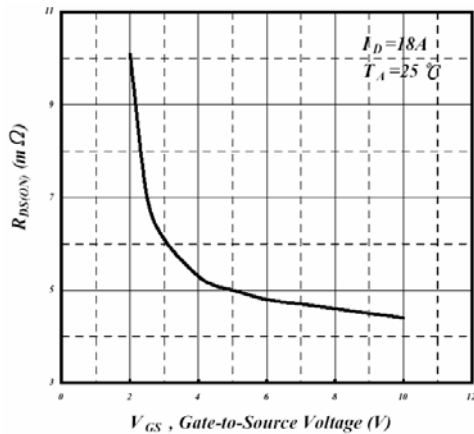
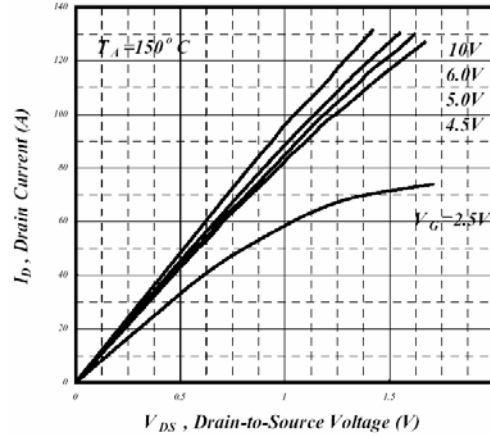
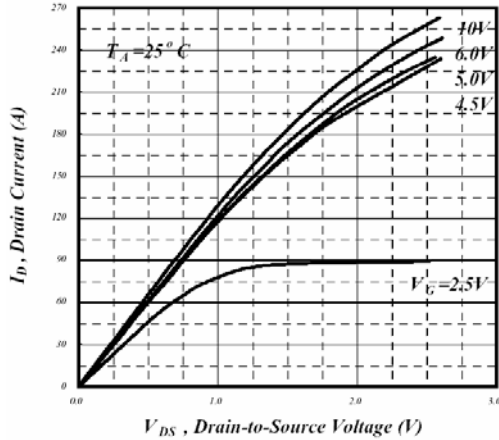
Note 1: Surface mounted on 1 in² copper pad of FR4 board; 125 $^\circ\text{C}/\text{W}$ when mounted on Min. copper pad.

Note 2: Pulse width limited by Max. junction temperature.

Note 3: Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.

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Typical Performance Characteristics



N-Channel Enhancement Mode Power MOSFET

■ Typical Performance Characteristics (Continued)

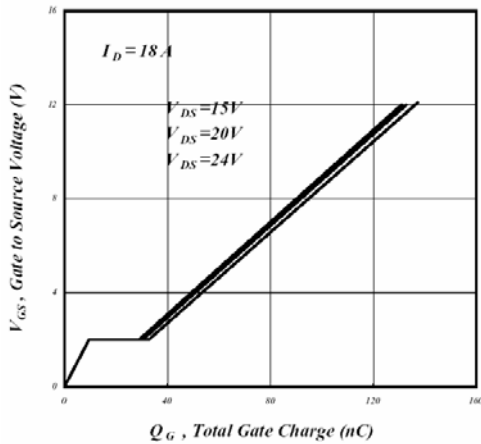


Fig 7. Gate Charge Characteristics

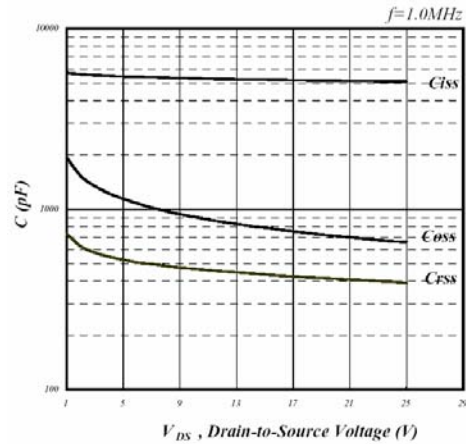


Fig 8. Typical Capacitance Characteristics

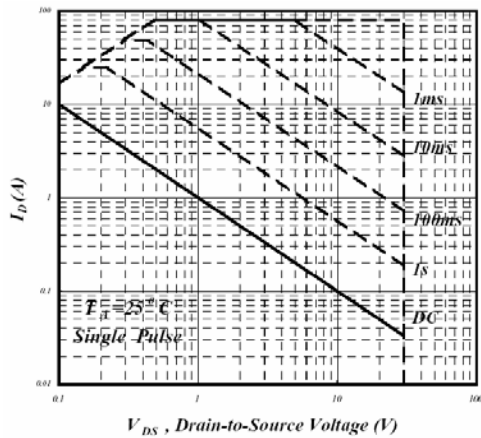


Fig 9. Maximum Safe Operating Area

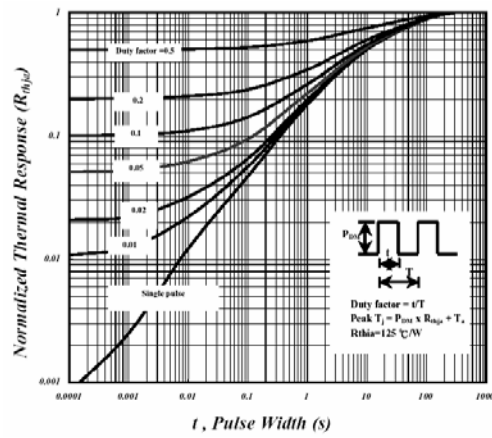


Fig 10. Effective Transient Thermal Impedance

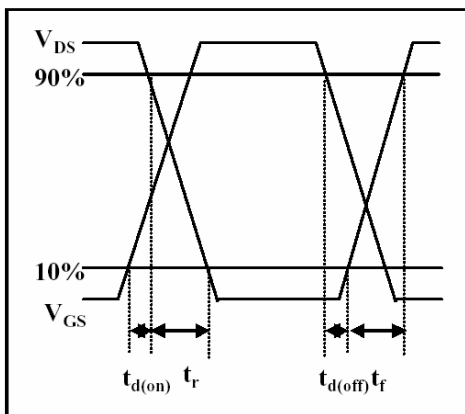


Fig 11. Switching Time Waveform

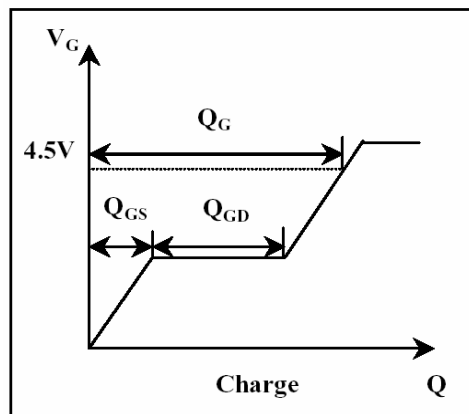
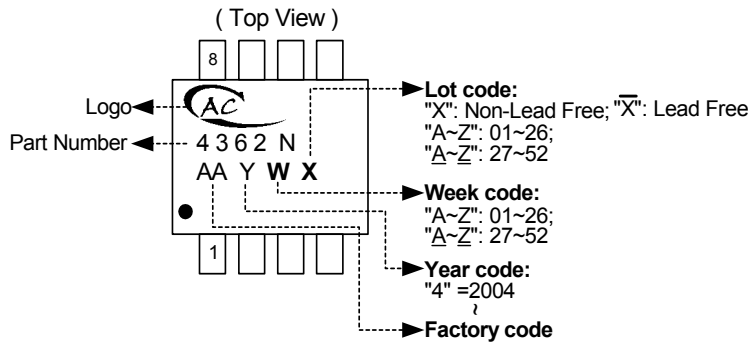


Fig 12. Gate Charge Waveform

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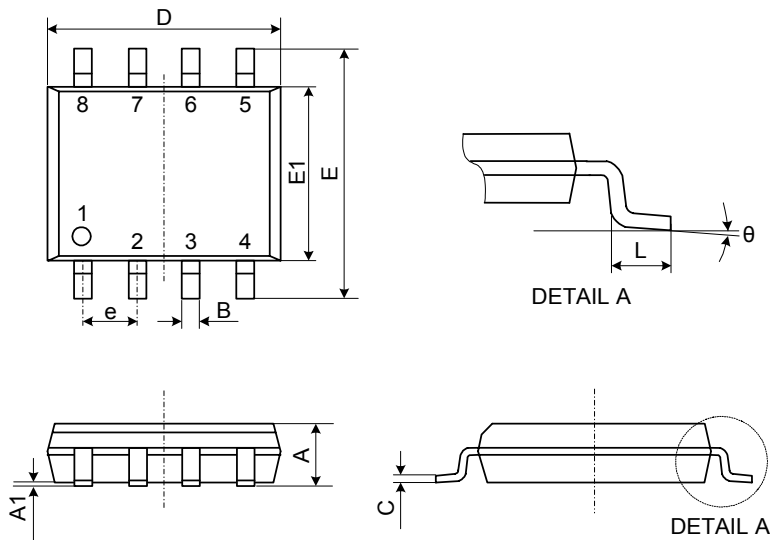
■ Marking Information

SO-8



■ Package Information

Package Type: SO-8



1. All Dimensions Are in Millimeters.
2. Dimension Does Not Include Mold Protrusions.

Symbol	Dimensions In Millimeters		
	Min.	Nom.	Max.
A	1.35	1.55	1.75
A1	0.10	0.18	0.25
B	0.33	0.41	0.51
C	0.19	0.22	0.25
D	4.80	4.90	5.00
E	5.80	6.15	6.50
E1	3.80	3.90	4.00
L	0.38	0.71	1.27
θ	0°	4°	8°
e	1.27 TYP.		